DELL[™] POWEREDGE[™] SERVERS 11TH GENERATION TRANSITION GUIDE





Servers on March 30th worldwide. This document is intended as guidance for product transitions from Dell's 10th Generation Server Products to 11th Generation Server Products.

Dell introduced the 11th Generation PowerEdge

STAND-ALONE RACK AND TOWER

WHAT'S NEW?	AFFECTED PRODUCTS	
	End of Life Product	Replacement Products
	PowerEdge 2950 III	PowerEdge R710
Chassis and ID	PowerEdge 1950 III	PowerEdge R610
Motherboard Processors	PowerEdge 2900 III	PowerEdge R410
Chipset	PowerEdge Energy Smart 2950 III	PowerEdge T610
Memory	PowerEdge Energy Smart 1950 III	
BIOS	PowerEdge 1900	
Firmware & Drivers		
Server Management iDRAC6 Internal SD-Module	The PowerEdge 1900 will be discontinued in April 2009	The PowerEdge R710, R610, and T610 will be factory ready on March 30, 2009
PSU HDD & SSD NICs & FC cards	The PowerEdge 2950 III and 1950 III will be discontinued in September 2009	The PowerEdge R410 will be factory ready on May 25, 2009
	The PowerEdge 2900 III will be discontinued in December 2009	

BLADE SERVERS

WHAT'S NEW?	AFFECTED PRODUCTS					
Motherboard	End of Life Product	Replacement Products				
Processors	PowerEdge M600	PowerEdge M610				
Chipset		PowerEdge M710 (new product)				
Memory BIOS	The PowerEdge M600 will be discontinued in	FowerEdge Millo (new product)				
Firmware & Drivers	September 2009					
Server Management						
Internal SD-Module						
HDD Carrier						
Fabric B Mezz card slot						

IMPORTANT TRANSITION INFORMATION

STAND-ALONE RACK AND TOWER SERVERS

- New Features:
 - Intel[®] Microarchitecture, codenamed Nehalem
 - DDR3 Memory Technology
 - Right-sized Energy Smart Power Supplies
 - Support for PCIe Gen 2
 - Improved system-level design efficiency
 - Lifecycle Controller
 - Unified Server Configurator
 - Dell Management Console
- The 11th Generation server images are not backward compatible to the previous generation servers
- The previous generation of servers will not support Xeon 5500 (Nehalem EP) processors
- Virtualization can be done across PowerEdge™
 1950 III, 2900 III, 2950 III, and 11th Generation
 PowerEdge R610/T610/R710
- Hard drive carriers are new. Older hard drives will fit in new carriers. Older carriers cannot be used in new servers
- The 11th Generation of servers will have new and improved rail kits (ReadyRails[™]) and cable management arms (CMAs). The previous generation rail kits (RapidRails[™] and VersaRails[™]) and CMAs will not work with the new servers.

TECHNOLOGY NOT SUPPORTED ON 11TH GENERATION STAND-ALONE RACKS AND TOWERS

- PERC 5
- Fully Buffered DIMMs (FBD)
- DRAC5
- PATA Optical Drives
- PCI-x
- Xeon 5400 (Harpertown) and Xeon 5200 (Wolfdale)
- Previous generation hard drive carriers
- Previous generation rail kits (RapidRails and VersaRails) and CMAs will not work with the new 11th generation of PowerEdge servers.

BLADE SERVERS

- New Features:
 - Intel Nehalem Architecture
 - DDR3 Memory Technology
- PowerEdge M610 images are not backward compatible to the previous generation servers
- PowerEdge M600 servers will not support Xeon 5500 (Nehalem EP) processors
- Some mezz cards will not fit in Fabric B of the PowerEdge M610 as the size of the mezz cards has shrunk on new cards. These cards can fit in Fabric C. The cards that will not fit:
 - FC4 HBAs
 - InfiniBand®
 - Broadcom[®] 5708 1Gb NIC



PowerEdge M710 and M610 in the M1000e Blade Chassis



STAND-ALONE RACK AND TOWER FEATURE COMPARISON

FEATURE / SPEC	PE T610	PE 1900	PE 2900 III
Processor	Intel® Xeon® 5500 Series (Nehalem EP)	Intel Xeon 5300 & 5100 Series Processors	Intel Xeon 5400 & 5200 Series Processors
	60W, 80W, and 90W	80W and 120W TDP options	80W and 120W TDP options
Front Side Bus	Intel® Quickpath Interconnect (QPI)	1066MHz, 1333MHz	1066MHz, 1333MHz
# Procs	1 or 2	1 or 2	1 or 2
# Cores	Quad or Dual	Quad or Dual	Quad or Dual
L2/L3 Cache	4MB and 8MB	2x4M (5300 Series) 4M (5100 series)	2x6MB (5400 Series) 6MB (5200 Series)
Chipset	Intel® 5520 (Tylersburg)	Intel 5000P (Blackford)	Intel 5000X (Greencreek)
DIMMs	12 x DDR3 800, 1066, 1333MHz DDR3 RDIMMs or UDIMMs	8 x FBD 667MHz FBD DIMMs	12 x FBD 667MHz FBD DIMMs
Min/Max RAM	1GB / 96GB	1GB / 24GB	1GB / 48GB
HD Bays	Hot Plug HDD 8x2.5" HDD + TBU (or) 8x3.5" HDD + TBU	1GB / 24GB Cabled HDD 6x3.5" HDD + TBU	Hot Plug HDD 10x3.5" HDD (or) 8x3.5" HDD + TBU
HD Types	SAS, SATA, Near-line SAS, SSD	SAS, SATA, Near-line SAS	SAS, SATA, Near-line SAS
Ext. Drive Bay(s)	External USB floppy & SATA optical drives	External USB floppy & SATA/PATA optical drives	External USB floppy & SATA/PATA optical drives
Int. HD Controller	SAS6iR or PERC6i	SAS5iR or PERC5i	SAS6iR, PERC6i or PERC5i
Opt. HD Controller	PERC 6/E	PERC 5/E	PERC 5/E and PERC 6/E
	Hot Plug HDD	Cabled HDD	Hot Plug HDD
	Hot Plug Redundant PSU	Cabled PSU	Hot Plug Redundant PSU
	Redundant Cooling	No Redundant Cooling	Redundant Cooling
Availability	ECC memory Mirroring Single Device Data Correction (SDDC)	ECC memory Spare Row, Mirroring Single Device Data Correction (SDDC)	ECC memory Spare Row, Mirroring Single Device Data Correction (SDDC)
Server Management	OpenManage™	OpenManage	OpenManage
Remote Management	iDRAC6 Enterprise	DRAC5	DRAC5
I/O Slots	5 PCIe Gen2	5 PCI	5 PCI
NIC/LOM	2 x TOE Broadcom 5709C	1 x TOE Broadcom 5708	2 x TOE Broadcom 5708
USB	6 in the back 2 in the front 1 internal	4 in the back 2 in the front	4 in the back 2 in the front 1 internal
	Hot-plug redundant PSUs	Cabled PSU	Hot-plug redundant PSU
Power Supplies	2 x 570W (Energy Smart PSU) (or) 2 x 870W (High Output PSU)	2 x 800W	2 x 930W
Fans	Optional Redundant Cooling	No redundant cooling	Optional Redundant Cooling
Chassis	Tower and 5U rack mount	Tower	Tower and 5U rack mount

FEATURE / SPEC	PE R710	PE 2950
Processor	Intel® Xeon® 5500 Series (Nehalem EP) 60W, 80W, and 90W Processors	Intel Xeon 5400 (Harpertown) & 5200 (Wolfdale) Series
Front Side Bus	Intel® Quickpath Interconnect (QPI)	1066 and 1333
# Procs	1 or 2	1 or 2
# Cores	Dual and Quad	Dual and Quad
L2/L3 Cache	4MB and 8MB	2x6MB (Harpertown) 6MB (Wolfdale)
Chipset	Intel® 5520 (Tylersburg)	Intel 5000X (Greencreek)
DIMMs	18 DDR3 (9 per proc) 800, 1066, 1333MHz DDR3 RDIMMs or UDIMMs	8 FBDIMMs
Min/Max RAM	1GB - 144GB	1GB - 64GB
HD Bays	6x3.5" 4x3.5" with the optional flex bay or 8x2.5	6x3.5" or 8x2.5
HD Types	Hot plug, SAS / SATA Nearline SAS and SSD	Hot plug, SAS / SATA Nearline SAS
Ext. Drive Bay(s)	Optional flex bay expansion to support half-height TBU	Optional flex bay expansion to support half- height TBU
Int. HD Controller	PERC6/i or SAS6/iR	PERC 6/i, SAS 6/iR, PERC 6/E, Gen 5 cards
Opt. HD Controller	PERC 6/E	PERC 5/E and PERC 6/E
Availability	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Single Device Data Correction (SDDC) Supports memory demand and patrol scrubbing High-availability failover cluster	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Spare Row Single Device Data Correction (SDDC) High-availability failover cluster support
Server Management	OpenManage™	OpenManage
Remote Management	Standard iDRAC6 Express with optional iDRAC6 Enterprise	Standard BMC with IMPI 2.0 supports optional DRAC 5/i
I/O Slots	2 PCle x8 + 2 PCle x4 G2 or 1 x16 + 2 x4 G2	3 PCIe or PCI-x
NIC/LOM	Broadcom® 5709C 4 x TOE	Broadcom 5708
USB	4 External 1 Internal	4 External 1 Internal
Power Supplies	Two hot-plug high-efficient 570W PSU or Two hot-plug 870W PSUs	2 x 750W redundant (optional) High-Efficiency & power monitoring PSU
Fans	5 Hot-plug, redundant fans	
Chassis	2U rack mount	2U rack mount



FEATURE / SPEC	PE R610	PE R410	PE 1950 III	
Processor	Intel® Xeon® 5500 Series (Nehalem EP) 60W, 80W, and 90W	Intel Xeon 5500 Series (Nehalem EP) 60W, 80W, and 90W	Intel Xeon 5400 (Harpertown) & 5200 (Wolfdale) Series	
Front Side Bus	Intel® Quickpath Interconnect (QPI)	Intel QuickPath Interconnect (QPI)	1066 and 1333	
# Procs	1 or 2	1 or 2	1 or 2	
# Cores	2 and 4	2 and 4	2 and 4	
L2/L3 Cache	4MB and 8MB	4MB and 8MB	2x6MB (Harpertown) 6MB (Wolfdale)	
Chipset	Intel Xeon 5520 (Tylersburg)	Intel Xeon 5520 (Tylersburg)	Intel [®] 5000x (Greencreek)	
DIMMs	12 DDR3 (6 per proc) 800, 1066, 1333MHz DDR3 RDIMMs or UDIMMs	8 DDR4 (4 per proc) UDIMM / RDIMM 1GB and 2GB - UDIMM	8 FBDIMMs	
Min/Max RAM	1GB - 96GB	1GB - 64GB	512MB - 64GB	
HD Bays	6x2.5" SAS	4x2.5" SAS, SATA 4x3.5" SAS, SATA	6x3.5" or 8x2.5"	
HD Types	Hot plug, SAS Nearline SAS and SSD	Hot plug or cabled Nearline SAS SSD	Hot plug, SAS / SATA / PATA Nearline SAS	
Int. HD Controller	PERC6/i or SAS6/iR	PERC6/i or SAS6/iR	PERC 6/i, SAS 6/iR,	
Opt. HD Controller	PERC 5/E and PERC 6/E	PERC 6/E	PERC 6/E, Gen 5 cards	
Availability	Hot-plug hard drives Hot-plug redundant power and redundant cooling ECC memory Single Device Data Correction (SDDC) Supports memory demand and patrol scrubbing High-availability failover cluster	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Single Device Data Correction (SDDC) Supports memory demand and patrol scrubbing	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Spare Row Single Device Data Correction (SDDC) High-availability failover cluster support	
Server Management	OpenManage	OpenManage	OpenManage	
Remote Management	Standard iDRAC6 with optional iDRAC6 Enterprise card	BMC, optional iDRAC6-Express and iDRAC6-Enterprise	Standard BMC with IMPI 2.0 supports optional DRAC 5/i	
I/O Slots	2 PCle x8 G2	1 PCIe x16G2	2 PCIe or PCI-x	
NIC/LOM	Broadcom® 5709C 4 x TOE iSCSI	Broadcom 5709 2 x 1GB	Broadcom 5708	
USB	4 External, 1 Internal	2 External	4 External, 1 Internal	
Power Supplies	Two hot-plug high-efficient Energy Smart 502W PSU or Two hot-plug High-output 717W PSUs	Smart 502W PSU or Two hot-plug Smart 480W PSU or Two hot-plug		
Fans	6 Hot-plug, redundant	Not redundant		
Chassis	1U rack mount	1U rack mount	1U rack mount	

RACK AND TOWER RAILS AND CABLE MANAGEMENT ARMS

RAILS

- Enable the replacement of thumbscrews with slam latches on the chassis for easier stowing in the rack.
- Include the new simple and intuitive ReadyRail™ tool-less rack interface for square-hole and roundhole racks.
- Provide significantly improved compatibility with non-Dell racks.
- Static rails for the R610 and R710 fit in all types of 4-post and 2-post racks available in the industry, including 4-post threaded hole racks.

CMAs

- Provide much larger vent pattern for improved airflow through the CMA.
- Include a common support tray for eliminating CMA sag.
- Replaced tie wraps with hook and loop straps to eliminate risk of cable damage during cycling.
- Maintain key feature of being fully reversible with no conversion required.

	PE 2950 III	PE R710	PE 1950 III	PE R610	PE 2900 III	PE T610
Dell™ PERC 6/i Integrated	~	~	~	~	~	~
Dell SAS 6/iR Integrated	~	~	~	~	~	~
Dell SAS 5/I Integrated	~		~		~	
Dell PERC 5/I Integrated	~		~		~	
Dell PERC 5/E Adapter	~		~		~	
Dell PERC 6/E Adapter (512 MB)	~	~	~	~	~	~
Dell PERC 6/E Adapter (256 MB)	~	~	~	~	~	~
Dell SAS 5/E Adapter	~	~	~	~	~	~
Intel [®] 10GBase-T Copper Single-Port NIC (Copperpond)	~	~	~	~	~	~
Broadcom [®] BCM57710 10GBase-T Copper Single-Port NIC (Quiver)	~	~	~	~	~	~
Intel [®] 10GBase-SR Optical Single-Port NIC (BelleFontaine)	~	~	~	~		~
Emulex [®] LPe12002 FC8 Dual-Channel HBA	~	~	~	~	~	~
Emulex LPe12000 FC8 Single-Channel HBA	~	~	~	~	~	~
Emulex LPe11002 FC4 Dual-Channel HBA	~	~	~	~	~	~
Emulex LPe1150 FC4 Single-Channel HBA	~	~	~	~	~	~
Intel® Gigabit VT Copper Quad Port NIC (Springport)	~	~	~	~	~	>
QLogic QLE2462 FC4 Dual-Channel HBA	~	~	~	~	~	~
QLogic QLE2460 FC4 Single-Channel HBA	~	~	~	~	~	~
LSI Logic LSI2032 SCSI HBA (Sasquatch)	~	~	~	~	~	~
QLogic QLE2562 FC8 Dual-Channel HBA	~	~	~	~	~	~
QLogic QLE2560 FC8 Single-Channel HBA	~	~	~	~	~	~
QLogic QLE220 FC4 Single-Channel HBA	~	~	~	~	~	~
Intel® PRO/1000PT Gigabit Copper Dual- Port NIC (Redwater)	~	v	~	~	v	v
Broadcom BCM5709C IPV6 Gigabit Copper Dual-Port NIC with TOE and iSCSI Offload (Dragonfly)	~	v	~	v	r	~
Broadcom BCM5709C IPv6 Gigabit Copper Dual-Port NIC with TOE (Dragonwing)	~	V	~	~	~	~
Intel PRO/1000PF Gigabit Optical Single-Port NIC (Sheepshead Bay)	~		~		v	~
Broadcom BCM5708 Gigabit Copper Single-Port NIC with TOE and iSCSI Offload (Riptide)	~		~		r	v
Adaptec 39320A PCI-X Lead-free SCSI Controller	~		~		~	

RACK AND TOWER PERIPHERAL CARD SUPPORT MATRIX



RACK AND TOWER HARD DISK SUPPORT MATRIX

	PE 2950 III	PE R710	PE 1950 III	PE R610	PE 2900 III	PE T610
2.5" HARD DRIVES						
160GB 7.2K SATA	~	~				~
250GB 7.2K SATA	~	~	~			~
500GB 7.2K SATA	~	~	~			~
80GB 7.2 SATA (Energy Smart)	~		~			
160GB 7.2K SATA (Energy Smart)	~	~	~			~
250GB 7.2K SATA (Energy Smart)	~	~	~			~
73GB 10K SAS	~	~	~	~		~
146GB 10K SAS	~	~	~	~		~
300GB 10K SAS	~	~	~	~		~
36GB 15K SAS			~			
73GB 15K SAS	~	~	~	~		~
146GB 15K SAS	~	~	~	~		~
300GB 15K SAS	✓*		~			
25GB Enterprise SSD	✓*	~	✓*	~		~
50GB Enterprise SSD	✓*	~	✓*	~		~
100GB Enterprise SSD	✓*	~	✓*	~		~
3.5" HARD DRIVERS						
80GB 7.2K SATA	~	~	 ✓ 		 ✓ 	
160GB 7.2K SATA	~	~	~		~	~
250GB 7.2K SATA	~	~	~		~	~
500GB 7.2K SATA	~	~	~			~
750GB 7.2K SATA		~	~			~
1,000GB (1TB) 7.2 SATA		~				~
500GB NL SAS	~	~			~	~
750GB NL SAS	~	~	~		~	~
1,000GB (1TB) NL SAS	~	~	~		~	~
73GB 10K SAS	~					
146GB 10K SAS						
300GB 10K SAS	~		~			
400GB 10K SAS	~		~		~	
600GB 10K SAS	~		~		~	
73GB 15K SAS	 ✓ 		~		~	
146GB 15K SAS	~	~	~		~	~
300GB 15K SAS		~	~		~	~
450GB 15K SAS	~	~	~		~	~
500GB 7.2K Enterprise SATAu		~			~	~
750GB 7.2K Enterprise SATAu	 ✓ 	~			~	~
1.000GB (1TB) 7.2 Enterprise SATAu	~	~	~		~	~

*Available June 2009.

BLADE SERVERS FEATURE COMPARISON

FEATURE / SPEC	PE M610	PE M600
Processor	Intel® Xeon® 5500 Series (Nehalem EP)	Intel Xeon 5400 (Harpertown) Series
Front Side Bus	Intel® Quickpath Interconnect (QPI)	1066 & 1333FSB
# Procs	2	2
# Cores	4	4
L2/L3 Cache	4MB and 8MB	2x6MB (Harpertown) 6MB (Wolfdale)
Chipset	Intel® 5520 (Tylersburg)	Intel Blackford
DIMMs	12 DDR3	8 FBD
Min/Max RAM	1GB - 96GB	1GB - 64GB
HD Bays (2.5" only)	2	2
HD Types	SAS/SATA/SSD	SAS/SATA/SSD
Int. HD Controller	SATA	SATA
Opt. HD Controller	PERC/CERC	CERC
Availability	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Single Device Data Correction (SDDC) Supports memory demand and patrol scrubbing High-availability failover cluster	Hot-plug hard drives Hot-plug redundant power and cooling ECC memory Spare Row Single Device Data Correction (SDDC) High-availability failover cluster support
Server Management	iDRAC Enterprise CMC (on M1000e)	iDRAC CMC (on M1000e)
Mezz Slots	2 x 8 (PCI 2.0)	2 (PCI 1.0)
RAID	O,1	O,1
NIC/LOM	2 Broadcom® 1Gb 5709	2 Broadcom 1Gb 5708
USB	2 external 1 internal	2 external
Power Supplies	See M1000e specifications	See M1000e specifications
Fans	See M1000e specifications	See M1000e specifications
Chassis	See M1000e specifications	See M1000e specifications



RACK, TOWER, AND BLADE OPERATING SYSTEM SUPPORT MATRIX

	PE 2950 III	PE R710	PE 1950 III	PE R610	PE 2900 III	PE T610	PE M710	PE M610
MICROSOFT®								
Windows [®] Small Business Server 2008, Standard Edition and Premium Edition	~	v	~	r	r	v	r	r
Windows [®] Essential Business Server 2008, Standard Edition and Premium Edition	~	V	~	r	r	V	r	r
Windows Server® 2008, Standard Edition, (x64 includes Hyper-V™)	~	~	~	V	~	~	~	r
Windows Server® 2008, Enterprise Edition, (x64 includes Hyper-V™)	~	V	~	~	~	~	~	v
Windows Server® 2008, Datacenter Edition, x64 with Hyper-V™	~	V	~	r	~	~	~	v
Windows [®] Web Server 2008	~	~	v	v	r	~	r	v
Windows [®] HPC Server 2008	~	~	~	V			~	v
LINUX/UNIX								
Red Hat [®] Enterprise Linux 4.7	Supported. Factory installation available in June 2009							
Red Hat® Enterprise Linux 5.2	~	V	~	~	~	V	~	~
Red Hat [®] Enterprise Linux 5.3	Supported. Factory installation available in June 2009							
Novell [®] SUSE [®] Linux Enterprise Server 10 SP2	~	~	r	v	r	~	r	v
Novell® SUSE® Linux Enterprise Server 11	Supported. Factory installation available in June 2009	Available in June 2009	Available in June 2009					
Solaris™ 10 10/08	~	Available in June 2009	~	Available in June 2009	~	Available in June 2009	Available in June 2009	Available in June 2009
VIRTUALIZATION								
VMWare® VI 3.5 Enterprise	~	~	~	v	~	~	r	v
VMWare ESXi v3.5 VI3	~	~	~	~	~	~	~	~
Citrix [®] XenServer [®]	~	~	~	~	~	~	~	~

INTEL® PROCESSOR GUIDANCE

- New Features:
 - Intel[®] Xeon[®] Processor 5500 Series
 - Intel[®] Turbo Boost Technology
 - Intel[®] Hyper-Threading Technology
 - Intel[®] Intelligent Power Technologies

CROSS-GENERATIONAL PROCESSOR PERFORMANCE COMPARISON

	CURRENT PRODUC	ſS	FU	ſURE	
5100 (Dual-Core Xeon)	5300 (1st Gen 65nm Quad-Core Xeon)	5400 (2nd Gen 45nm Quad-Core Xeon)	5500 Nehalem microarchitecture		
5160 (3.00GHz)	X5365 (3.00GHz) X5355 (2.66GHz) E5345 (2.33GHz)	X5470 (3.33GHz) X5460 (3.16GHz) E5450 (3.00GHz)	X5570 (2.93GHz) X5560 (2.80GHz) X5550 (2.66GHz)	Advanced Performance-oriented customers seeking highest functionality and optimal server ROI	
5150 (2.66GHz) 5140 (2.33GHz) 5130 (2.00GHz)	E5335 (2.00GHz) E5320 (1.86GHz)	E5440 (2.83GHz) E5430 (2.66GHz) E5420 (2.50GHz)	E5540 (2.53GHz) E5530 (2.40GHz) E5520 (2.26GHz)	Standard Customers seeking a mix of performance, value, and advanced features	
5120 (1.86GHz) 5110 (1.60GHz)	E5310 (1.60GHz)	E5410 (2.33GHz) E5405 (2.00GHz)	E5506 (2.13GHz) E5504 (2.00GHz) E5502 (1.86GHz)	Basics Cost-sensitive customers seeking basic features	

DDR3 MEMORY TECHNOLOGY

Dell servers released March 2009 use the new Intel Xeon 5500 Series Processor that supports the new DDR3 memory technology. Each CPU has three separate memory controller hubs (MCH) within the CPU package. Memory transactions no longer need to transfer between the CPU and another external device.

- Features
 - Memory-Optimized Mode
 - Advanced ECC Mode (allows x8 SDDC)
 - Mirror Mode



COMPARISON BETWEEN UDIMM AND RDIMM TECHNOLOGIES SUPPORTED BY DELL

	UDIMM	RDIMM
Register/Buffer	No	Yes
Frequencies	800, 1066, 1333MHz	800, 1066, 1333MHz
Ranks Supported	1 or 2	1, 2, or 4
Capacity per DIMM	1 or 2GB	1, 2, 4, or 8GB
Max # DIMMs per Channel	2	3
DRAM Technology	x8	x4 or x8
Temperature Sensor	Yes	Yes
ECC	Yes	Yes
SDDC	Yes (with advanced ECC mode)	Yes
Address Parity	No	Yes

RDIMMS

• Customers who need large amounts of memory (up to 8GB DIMMs), a broader future memory expansion roadmap (due to the ability to achieve 3 DIMMs/Channel), and the latest RAS features (address parity).

UDIMMS

• Customers who need a limited amount of memory and are looking for power and cost savings.

MEMORY CONFIGURATIONS

Each CPU has three integrated MCHs, which have their own memory channel. Memory can be accessed across CPUs or the system can be configured in a non-uniform memory architecture (NUMA). This can be configured via a BIOS configuration setting.

MEMORY FREQUENCY LIMITATIONS

Due to technology limitations, the frequency supported has some dependency on the DPC and the ranks used in a DIMM.

DIMM TYPE	DIMM O	DIMM 1	DIMM 2	# OF DIMMS	800	1066	1333
	SR			1			
	DR			1			
UDIMM	SR	SR		2			
	SR	DR		2			
	DR	DR		2			
	SR			1			
	DR			1			
	QR			1			
	SR	SR		2			
	SR	DR		2			
	DR	DR		2			
RDIMM	QR	SR		2			
	QR	DR		2			
	QR	QR		2			
	SR	SR	SR	3			
	SR	SR	DR	3			
	SR	DR	DR	3			
	DR	DR	DR	3			

Supported

Not Supported

SR - Single Rank DR - Dual Rank

QR - Quad Rank

DELL™ MANAGEMENT CONSOLE

With the launch of the PowerEdge[™] 11th Generation servers, Dell will also release Dell Management Console (DMC) powered by Altiris[™] from Symantec[®], a single view into the deployment, inventory, monitoring, and update of your IT infrastructure as well as a foundation for more advanced management functionality. This product will be a replacement for Dell IT Assistant.

NEW FEATURES WITH DMC (OVER IT ASSISTANT)

- MIB Import for non-Dell hardware alerting
- Additional Device Support: FC Switches
- Additional Hypervisor Support: ESXi
- Correlation between VMs and physical host (ESXi and Hyper-V[™])
- Enhanced Reporting
- New GUI-based script builders for OMSA CLI, BMC, and BIOS configuration
- Granular Active Directory Import and Role-Based Security
- Ability to configure personalized dashboards

IT ASSISTANT LIFECYCLE PLAN

- IT Assistant 8.3 was the last version with new features
- New Device Support will be added to IT Assistant through 2009
- IT Assistant will not support 12th Generation platforms and forward

DELL MANAGEMENT CONSOLE TRANSITION RESOURCES

- White Papers and Dell Management Console Documentation
- Migration Wizards within Dell Management Console
- Infrastructure Consulting Service: Rapid Deployment of Dell Management Console

OUT OF BAND MANAGEMENT

The Integrated Dell Remote Access Controller 6 (or iDRAC6) is designed to make server administrators more productive and improve the overall availability of Dell servers. The iDRAC6 achieves this by alerting administrators to server problems, enabling remote server management, and reducing the need for the administrator to physically visit the server. iDRAC6 is available in two levels: iDRAC6 Express and iDRAC6 Enterprise.

WHAT'S NEW?	AFFECTED PRODUCTS	
 iDRAC6 offers three upgrades: iDRAC6 Express, iDRAC6 Enterprise, and VFlash Media 	End of Life Product	Replacement Products
iDRAC6 offers power budgeting	DRAC4 DRAC4/MC	iDRAC (blades) DRAC5
 iDRAC6 Enterprise's virtual console and virtual media features are now integrated into a single plug-in 		
 iDRAC6 Enterprise's virtual console now allows two users to collaborate on the same server 		
 iDRAC6 now allows customers to view what is on the server LCD without a server-side visit 		
 iDRAC6 Express (which integrates a host of features previously charged for in DRAC5) is now a standard offering on Dell's enterprise-class servers 		
 As with iDRAC, iDRAC6 Enterprise is a standard offering on blade servers 		
• iDRAC6 supports the new industry Internet protocol IPv6		



Dates subject to change without notice.